

JC997 U.S. PRO
09/880715

		Subclass	ISSUE CLASSIFICATION
		Class	

PATENT NUMBER

U.S. UTILITY Patent Application

SA SCANNED <u>SP 3/2</u> Q.A. <u>LR</u>	O.I.P.E.	PATENT DATE
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APPLICATION NO.	CONT/PRIOR	CLASS	SUBCLASS	ART UNIT	EXAMINER
09/880715	D	438		2823	

APPlicants

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III

Method for filling recessed micro-structures with metallization in the production of a microelectronic device

PTO-2040
12/89

ISSUING CLASSIFICATION

<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.				NOTICE OF ALLOWANCE MAILED	
	(Assistant Examiner) _____ (Date) _____				
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____				ISSUE FEE	
	(Primary Examiner) _____ (Date) _____			Amount Due	Date Paid
<input type="checkbox"/> The terminal _____ months of				ISSUE BATCH NUMBER	

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